

## A700X226M035ATE025

A700, Polymer Aluminum, 22  $\mu$ F, 20%, 35 VDC, -55/+125°C, Height Max = 4.3mm



Click [here](#) for the 3D model.

### Dimensions

L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	4mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm

### Packaging Specifications

Packaging	T&R, 180mm
Packaging Quantity	500

### General Information

Series	A700
Dielectric	Polymer Aluminum
Style	SMD Chip
Description	Surface Mount, Polymer Aluminum
RoHS	Yes
Termination	Tin
Qualifications	UL94V-0
AEC-Q200	No
Halogen Free	Yes
Component Weight	305.03 mg
Footprint	7343
Shelf Life	104 Weeks
MSL	3

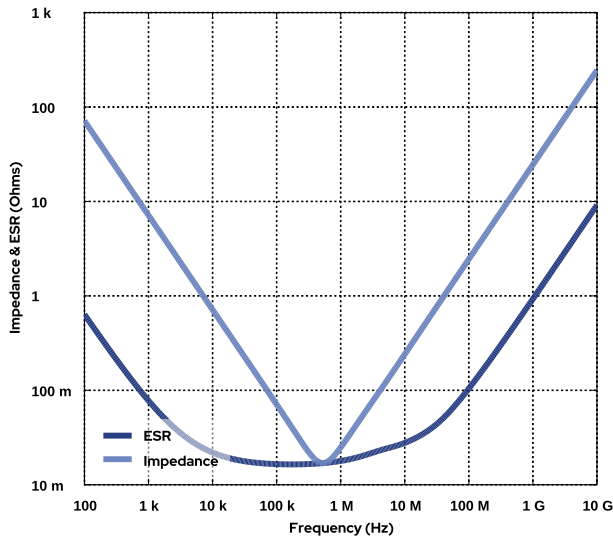
### Specifications

Capacitance	22 $\mu$ F
Capacitance Tolerance	20%
Voltage DC	35 VDC
Temperature Range	-55/+125°C
Rated Temperature	125°C
Life	2000 Hrs (125C)
Dissipation Factor	6% 120Hz 25C
Resistance	25 mOhms (100kHz 25C)
Ripple Current	3000 mA (rms 100kHz)
Leakage Current	77 $\mu$ A (5min 25°C)

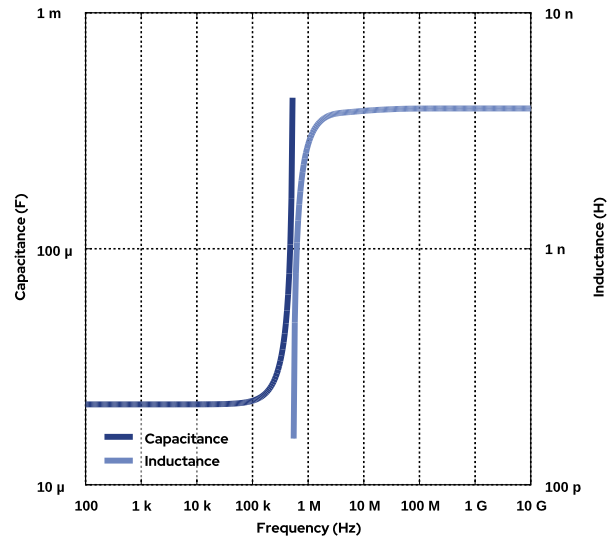
## Simulations

For the complete simulation environment please visit [K-SIM](#).

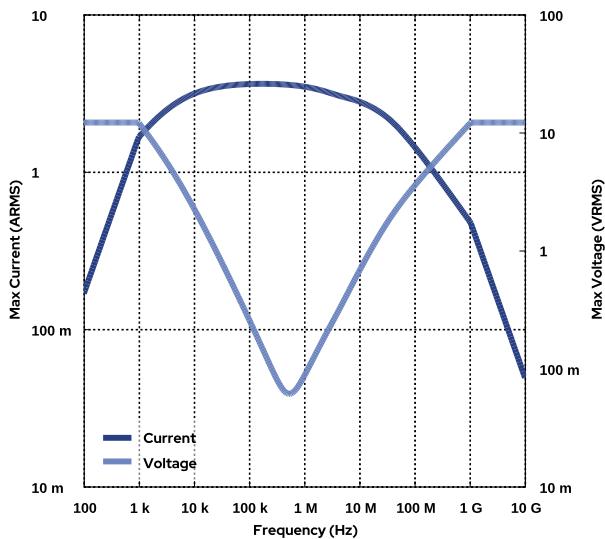
**Impedance and ESR**



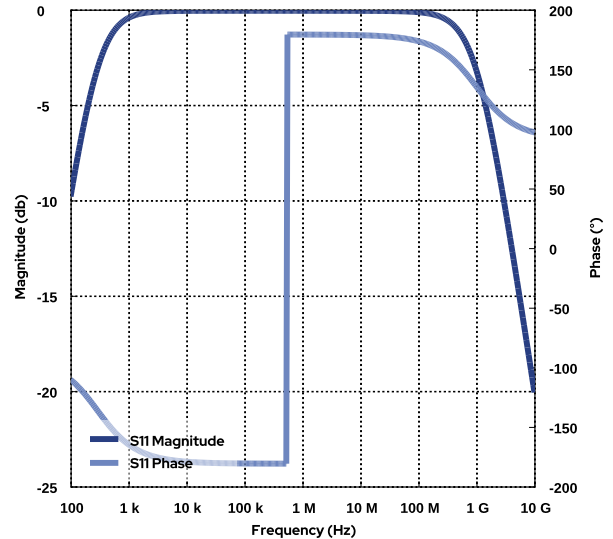
**Capacitance and Inductance**

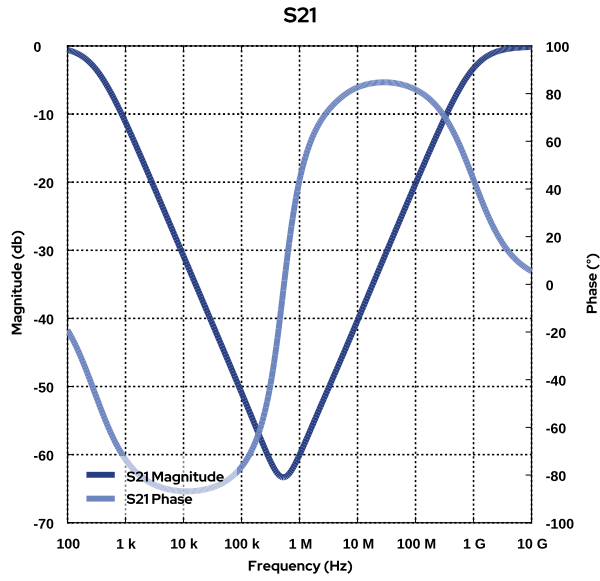


**Current and Voltage**



**S11**





**These are simulations.**

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.